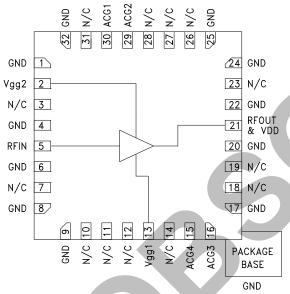
GaAs pHEMT MMIC 1 WATT POWER AMPLIFIER, DC - 22 GHz

Typical Applications

The HMC797ALP5E is ideal for:

- Test Instrumentation
- Microwave Radio & VSAT
- · Military & Space
- Telecom Infrastructure
- Fiber Optics

Functional Diagram



Features

High P1dB Output Power: 28 dBm High Psat Output Power: 29.5 dBm

High Gain: 13.5 dB

High Output IP3: 39 dBm

Supply Voltage: +10 V @ 400 mA 50 Ohm Matched Input/Output

32 Lead 5x5 mm SMT Package: 25 mm²

General Description

The HMC797ALP5E is a GaAs MMIC pHEMT Distributed Power Amplifier which operates between DC and 22 GHz. The amplifier provides 13.5 dB of gain, 39 dBm output IP3 and +28 dBm of output power at 1 dB gain compression while requiring 400 mA from a +10 V supply. This versatile PA exhibits a positive gain slope from 4 to 20 GHz making it ideal for EW, ECM, Radar and test equipment applications. The HMC797ALP5E amplifier I/Os are internally matched to 50 Ohms facilitating integration into mutli-chipmodules (MCMs), is packaged in a leadless QFN 5x5 mm surface mount package, and requires no external matching components.

Electrical Specifications, $T_A = +25^{\circ}$ C, Vdd = +10 V, Vgg2 = +3.5 V, Idd = 400 mA*

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range	DC - 12		12 - 18			18 - 22			GHz	
Gain	11	12.5		11	13.5		11	13.5		dB
Gain Flatness		±0.7			±0.5			±0.5		dB
Gain Variation Over Temperature		0.012			0.008			0.008		dB/ °C
Input Return Loss		13			15			15		dB
Output Return Loss		12			16			13		dB
Output Power for 1 dB Compression (P1dB)	26	28		25	27		23.5	25.5		dBm
Saturated Output Power (Psat)		29.5			29			27		dBm
Output Third Order Intercept (IP3)		39			37			35		dBm
Noise Figure		3.5			4			6		dB
Supply Current (Idd) (Vdd= 10V, Vgg1= -0.8V Typ.)		400	440		400	440		400	440	mA

^{*} Adjust Vgg1 between -2 to 0 V to achieve Idd = 400 mA typical.

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Absolute Maximum Ratings

Nominal Drain Supply to GND	+12.0 V
Gate Bias Voltage (Vgg1)	-3.0 to 0 Vdc
Gate Bias Current (Igg1)	< +10 mA
Gate Bias Voltage (Vgg2)	+2.0 V to (Vdd - 6.5 V)
Gate Bias Current (Igg2)	< +10 mA
Continuous Pdiss (T= 85 °C) (derate 69 mW/°C above 85 °C)	4.5 W
RF Input Power	+27 dBm
Output Power into VSWR >7:1	+29 dBm
Storage Temperature	-65 to 150 °C
Max Peak Reflow Temperature	260 °C
ESD Sensitivity (HBM)	Class 1A

Reliability Information

Junction Temperature to Maintain 1 Million Hour MTTF	150 °C
Nominal Junction Temperature (T=85 °C, Vdd = 10 V)	144 °C
Thermal Resistance (channel to ground paddle)	14.6 °C/W
Operating Temperature	-40 to +85 °C

Typical Supply Current vs. Vdd

PIN 1

EXPOSED

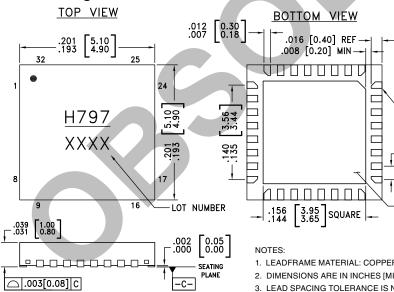
GROUND

PADDLE

_		
	Vdd (V)	ldd (mA)
	+9	400
	+10	400
	+11	400

ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing



- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.